

30 V P-channel MOSFET with pre-biased NPN transistor15 May 2013Product data sheet

### 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in Trench MOSFET technology and NPN Resistor-Equipped Transistor (RET) together in a leadless medium power DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- Trench MOSFET technology
- NPN transistor built-in bias resistors
- Small and leadless ultra thin SMD plastic package: 2 x 2 x 0.65 mm
- Exposed drain pad for excellent thermal conduction

### 3. Applications

- Charging switch for portable devices
- High-side load switch
- USB port overvoltage protection
- Power management in battery-driven portables
- Hard disk and computing power management

# 4. Quick reference data

Table 1. Qui	ck reference data						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
P-channel Tre	nch MOSFET						
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-30	V
V <sub>GS</sub>	gate-source voltage	-		-12	-	12	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-	-3.4	А
P-channel Tre	nch MOSFET; static cha	aracteristics		1	- 1		
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = -4.5 V; I <sub>D</sub> = -2.6 A; T <sub>j</sub> = 25 °C		-	85	110	mΩ
NPN RET							
V <sub>CEO</sub>	collector-emitter voltage	T <sub>amb</sub> = 25 °C; open base		-	-	50	V
I <sub>O</sub>	output current			-	-	100	mA

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
NPN RET						
R1	bias resistor 1		3.3	4.7	6.1	kΩ
R2	bias resistor 2		-	47	-	kΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>

# 5. Pinning information

Table 2.	Pinning	information			
Pin	Symbol	Description	Simplified outline	Graphic symbol	
1	E	emitter	6 5 4	C G S	
2	В	base			
3	D	drain	7 8		
4	S	source			
5	G	gate			
6	С	collector	Transparent top view DFN2020-6 (SOT1118)	E B D 017aaa396	
7	С	collector	2	017888390	
8	D	drain			

# 6. Ordering information

Table 3. Ordering information							
Type number Package							
	Name	Description	Version				
PMC85XP	DFN2020-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body $2 \times 2 \times 0.65$ mm	SOT1118				

# 7. Marking

Table 4. Marking codes	
Type number	Marking code
PMC85XP	1К

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### 8. Limiting values

#### Table 5. Limiting values

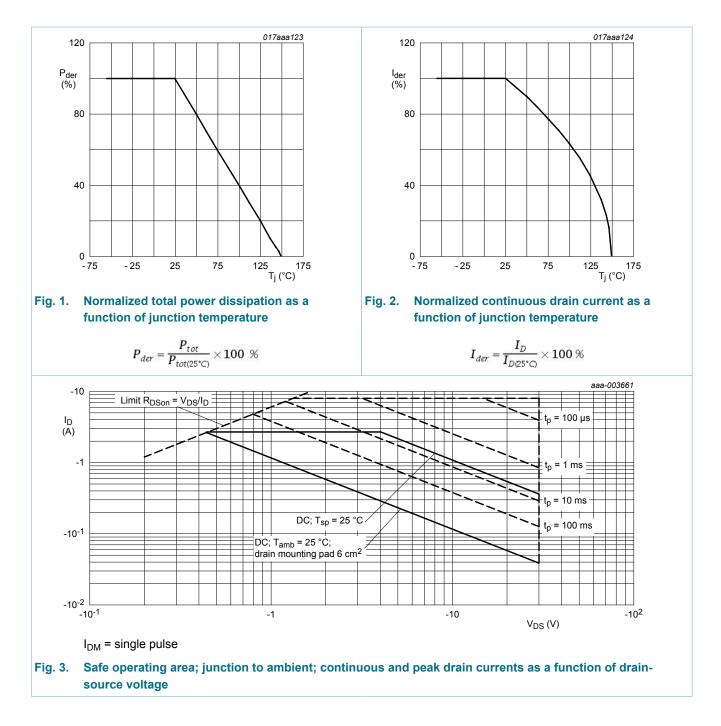
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
P-channel	Trench MOSFET	· · · · · · · · · · · · · · · · · · ·				
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-30	V
V <sub>GS</sub>	gate-source voltage			-12	12	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C; t ≤ 5 s	[1]	-	-3.4	Α
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C	[1]	-	-2.6	А
	V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 100 °C	[1]	-	-1.6	А	
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-8	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	485	mW
			[1]	-	1170	mW
		T <sub>sp</sub> = 25 °C	[2]	-	8300	mW
P-channel	Trench MOSFET; source-drain	diode	,		·	
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-1.2	А
NPN RET			- 1			,
V <sub>CBO</sub>	collector-base voltage	T <sub>amb</sub> = 25 °C; open emitter		-	50	V
V <sub>CEO</sub>	collector-emitter voltage	T <sub>amb</sub> = 25 °C; open base		-	50	V
V <sub>EBO</sub>	emitter-base voltage	T <sub>amb</sub> = 25 °C; open collector		-	10	V
VI	input voltage	positive		-	30	V
		negative		-	-5	V
I <sub>O</sub>	output current			-	100	mA
I <sub>CM</sub>	peak collector current			-	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	465	mW
			[1]	-	985	mW
		T <sub>sp</sub> = 25 °C	[2]	-	4160	mW
Per device	)					
Tj	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>

[2] Device mounted on an FR4 PCB, single-sided copper; tin-plated and standard footprint.

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### 9. Thermal characteristics

Table 6.	Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
P-channel	P-channel Trench MOSFET							
R <sub>th(j-a)</sub> thermal resistance from junction to ambient	thermal resistance	in free air	[1]	-	223	256	K/W	
		[2]	-	93	107	K/W		
	ampient	t ≤ 5 s; in free air	[2]	-	55	63	K/W	
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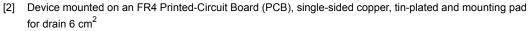
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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	10	15	K/W
NPN RET							_
R <sub>th(j-a)</sub>	thermal resistance	in free air	[1]	-	233	270	K/W
	from junction to ambient		[2]	-	110	127	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	25	30	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.



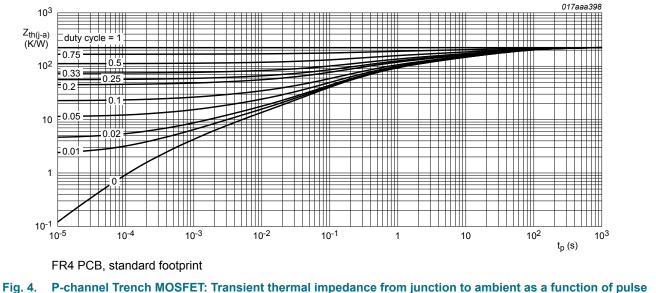
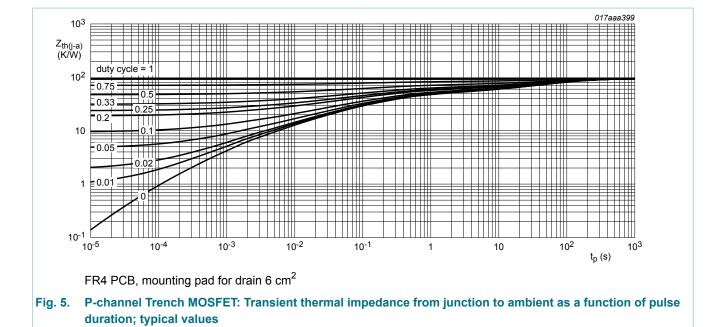


Fig. 4. P-channel Trench MOSFET: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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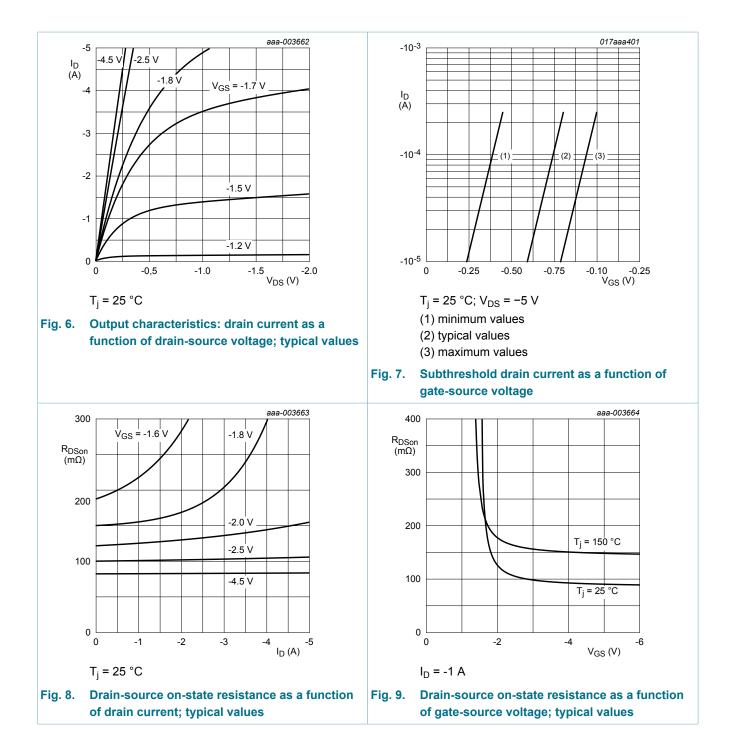
### **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P-channel	French MOSFET; static cha	aracteristics	I			
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D$ = -250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-30	-	-	V
V <sub>GSth</sub>	gate-source threshold voltage	$I_D$ = -250 mA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-0.45	-0.78	-1	V
I <sub>DSS</sub> drain leakage current	$V_{DS}$ = -30 V; $V_{GS}$ = 0 V; $T_{amb}$ = 25 °C	-	-	-1	μA	
		$V_{DS}$ = -30 V; $V_{GS}$ = 0 V; $T_{amb}$ = 150 °C	-	-	-11	μA
I <sub>GSS</sub>	ss gate leakage current	V <sub>GS</sub> = 12 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	100	nA
	$V_{GS}$ = -12 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA	
R <sub>DSon</sub>	drain-source on-state	$V_{GS}$ = -4.5 V; I <sub>D</sub> = -2.6 A; T <sub>j</sub> = 25 °C	-	85	110	mΩ
	resistance	$V_{GS}$ = -4.5 V; I <sub>D</sub> = -2.6 A; T <sub>j</sub> = 150 °C	-	133	173	mΩ
		$V_{GS}$ = -2.5 V; I <sub>D</sub> = -1.5 A; T <sub>j</sub> = 25 °C	-	105	140	mΩ
9 <sub>fs</sub>	transfer conductance	V <sub>DS</sub> = -10 V; I <sub>D</sub> = -2.6 A; T <sub>j</sub> = 25 °C	-	10	-	S
P-channel	French MOSFET; dynamic	characteristics	I			
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = -15 V; I <sub>D</sub> = -2.6 A; V <sub>GS</sub> = -4.5 V;	-	5.2	7.8	nC
Q <sub>GS</sub>	gate-source charge	T <sub>j</sub> = 25 °C	-	1.1	-	nC
Q <sub>GD</sub>	gate-drain charge		-	0.95	-	nC
C <sub>iss</sub>	input capacitance	$V_{DS}$ = -15 V; f = 1 MHz; $V_{GS}$ = 0 V;	-	680	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	54	-	pF

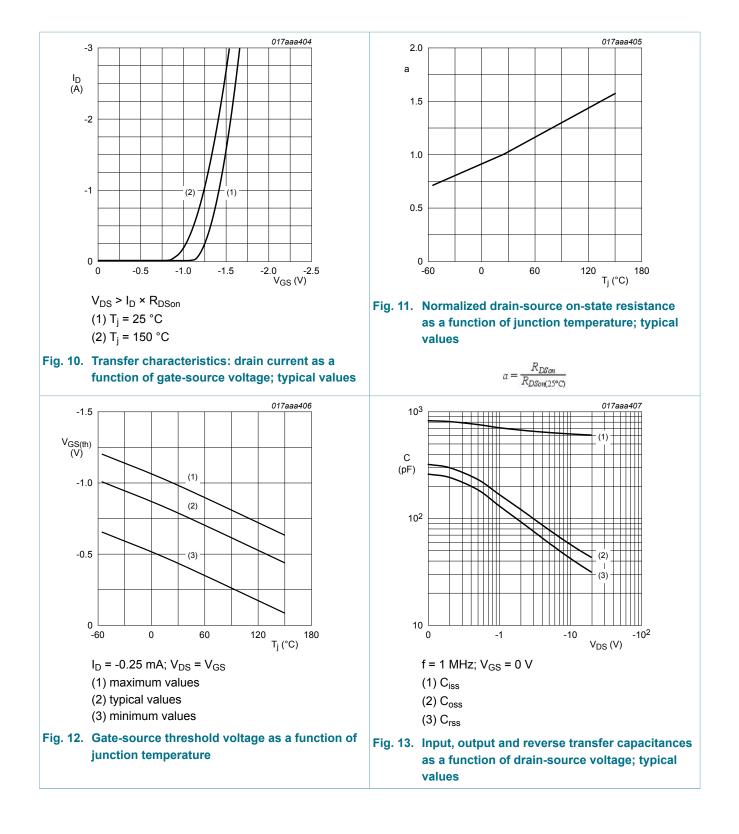
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Symbol	Parameter	Conditions	N	lin	Тур	Мах	Unit
C <sub>rss</sub>	reverse transfer capacitance		-		40	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = -15 V; $I_D$ = -2.6 A; $R_{G(ext)}$ = 6 $\Omega$ ;	-		3	-	ns
t <sub>r</sub>	rise time	V <sub>GS</sub> = -4.5 V; T <sub>j</sub> = 25 °C	-		15	-	ns
t <sub>d(off)</sub>	turn-off delay time	-	-		112	-	ns
t <sub>f</sub>	fall time		-		48	-	ns
P-channel	Trench MOSFET; source-dr	ain diode	I				
V <sub>SD</sub>	source-drain voltage	$I_{S}$ = -1.2 A; $V_{GS}$ = 0 V; $T_{j}$ = 25 °C	-		-0.8	-1.2	V
NPN RET	!		I				
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 50 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 25 °C	-		-	100	nA
I <sub>CEO</sub>	EO collector-emitter cut-off	$V_{CE}$ = 30 V; I <sub>B</sub> = 0 A; T <sub>j</sub> = 25 °C	-		-	1	μA
	current	V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0 A; T <sub>j</sub> = 150 °C	-		-	50	μA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A; T <sub>j</sub> = 25 °C	-		-	170	μA
h <sub>FE</sub>	DC current gain	$V_{CE}$ = 5 V; I <sub>C</sub> = 10 mA; T <sub>j</sub> = 25 °C	1	00	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 5 mA; I <sub>B</sub> = 0.25 mA; Τ <sub>j</sub> = 25 °C	-		-	100	mV
V <sub>I(off)</sub>	off-state input voltage	$I_{C}$ = 100 µA; $V_{CE}$ = 5 V; $T_{j}$ = 25 °C	-		0.6	0.5	V
V <sub>I(on)</sub>	on-state input voltage	I <sub>C</sub> = 5 mA; V <sub>CE</sub> = 0.3 V; T <sub>j</sub> = 25 °C	1	.3	0.9	-	V
R1	bias resistor 1		3	3.3	4.7	6.1	kΩ
R2	bias resistor 2		-		47	-	kΩ
R2/R1	bias resistor ratio		8	3	10	12	
C <sub>C</sub>	collector capacitance	$I_{E} = 0 \text{ A}; i_{e} = 0 \text{ A}; f = 1 \text{ MHz}; T_{j} = 25 \text{ °C}; V_{CB} = 10 \text{ V}$	-		-	2.5	pF

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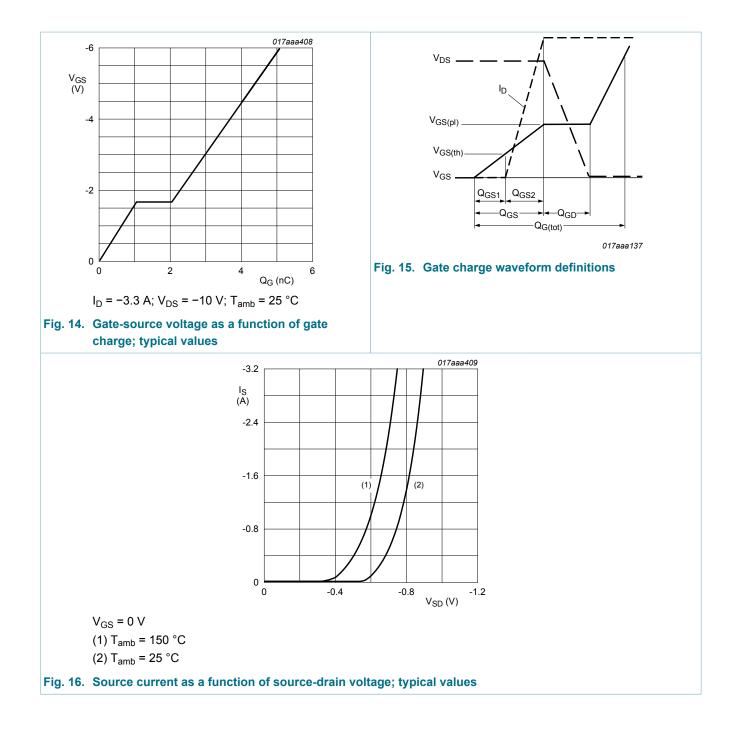
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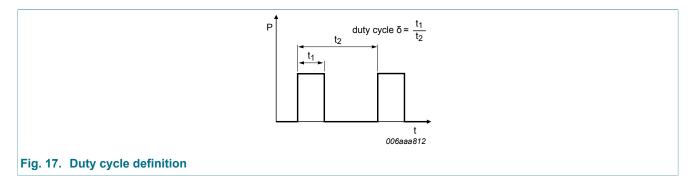
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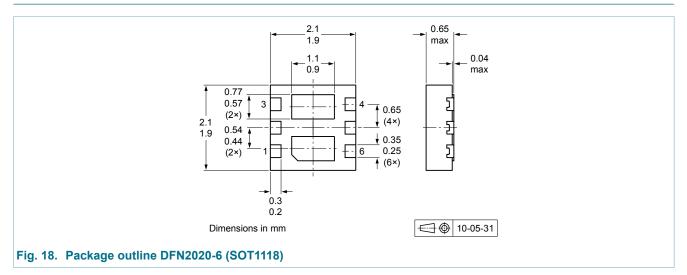
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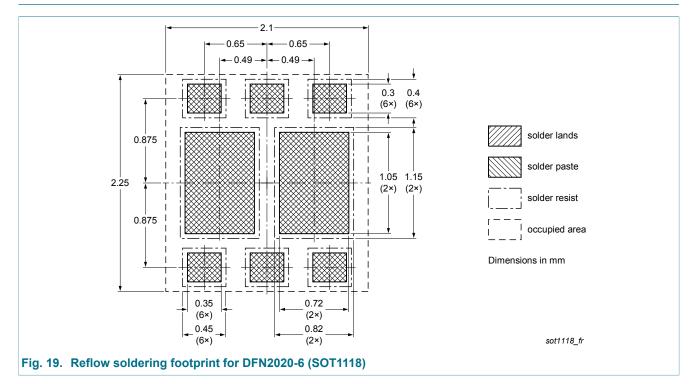
# 11. Test information



# 12. Package outline



# **13. Soldering**



# 14. Revision history

Table 8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMC85XP v.2	20130515	Product data sheet	-	PMC85XP v.1		
Modifications:	Pinning information: graphic symbol corrected					
PMC85XP v.1	20120524	Product data sheet	-	-		

### **15. Legal information**

#### 15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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